8th **AUTOMOTIVE** WORLD **2016**



Outline of Exhibition

CMK will exhibit at "Car Electronics Technology Exhibition" & "PWB EXPO" of "Internepcon 2016",on Jan 13th~15th, 2016.

We will introduce the various PWB's for Automotive, Consumer Appliances, Medical Devices and Others.

We are looking forward for you to come and see our booth!

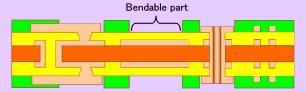
Site : Tokyo Big Sight



Most suitable for wearable devices!

High Density Thinner Multi-layer FPC

- The 4 layer surface mount PWB is only 0.18mm thick.
- •The structure of BVH (Filled VIA) allows higher densities.





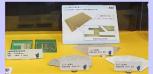
Points!

CAR-ELE JAPAN 8th Int'l Automotive Electronics Technology Expo

Period: $2016/1/13[Wed] \sim 1/15[Fri]$

High Frequency PWB

• PWB adopted low Dk/Df materials to cover high frequency electronics.(ex;milimeter-wave rader)





SEPT_® Series

•PWB can prevent solder cracks with high reliability.





CARFT® Series

•PWB capable for automotive engine mounting.

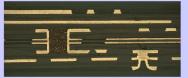




1*G-RF*

 Camera Module PWB's meet reliability requirements for automotive applications by using Rigid-Flex.





West hall W5-9

Points!

PWB EXPO 17th Printed Wiring Boards Expo

PPBU® (Suitable for thin type modules)

- *High Reliability &"thin" PWB's using glass cloth on all layers.
- PWB adopted structures of Any-layer allows downsizing.





2G-RF

·Rigid-Flex Ultra-Thin PWB's.





1G-RF (with Halogen-free material, high rigidity)

• PWB's with high rigidity and thinness for module appliances by using Rigid-Flex.





PCBA

•We will support all aspects of PWB's, Design, Production, and Assembly.





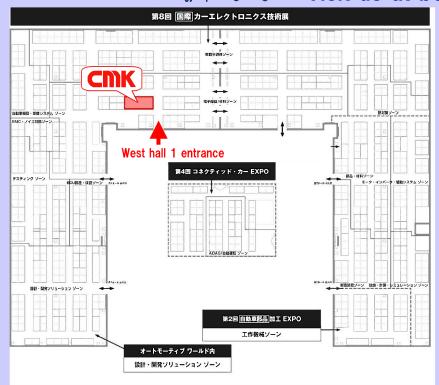
East hall E50-4

Map for the CMK exhibition booth location



CAR-ELE JAPAN 8th Int'l Automotive Electronics Technology Expo

Visit us at booth :West hall W5-9



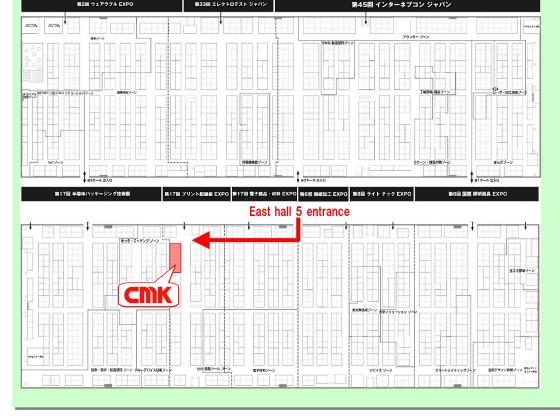








Visit us at booth :East hall E50-4









We will show new presentations related to our new technologies. Please come and visit our booth!